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TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSV)

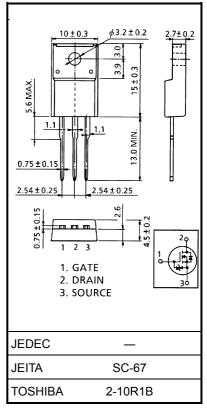
2SK2996

DC–DC Converter, Relay Drive and Motor Drive Applications

- Low drain-source ON resistance $R_{DS}(ON) = 0.74 \Omega$ (typ.)
- High forward transfer admittance $|Y_{fs}| = 6.8 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 600 \ V)$
- Enhancement-mode : $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit | |
|--|----------------|------------------|---------|------|--|
| Drain-source voltage | | V _{DSS} | 600 | V | |
| Drain-gate voltage (R _{GS} = 20 kΩ) | | V _{DGR} | 600 | V | |
| Gate-source voltage | | V _{GSS} | ±30 | V | |
| Drain current | DC (Note 1) | ۱ _D | 10 | А | |
| | Pulse (Note 1) | I _{DP} | 30 | A | |
| Drain power dissipation (Tc = 25°C) | | PD | 45 | W | |
| Single pulse avalanche energy (Note 2) | | E _{AS} | 252 | mJ | |
| Avalanche current | | I _{AR} | 10 | А | |
| Repetitive avalanche energy (Note 3) | | E _{AR} | 4.5 | mJ | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature range | | T _{stg} | -55~150 | °C | |



Weight: 1.9 g (typ.)

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|--------|
| Thermal resistance, channel to case | R _{th (ch−c)} | 2.78 | °C/W |
| Thermal resistance, channel to ambient | R _{th (ch−a)} | 62.5 | °C / W |

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 4.41 mH, R_G = 25 Ω , I_{AR} = 10 A

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

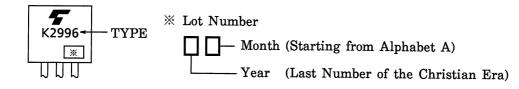
Electrical Characteristics (Ta = 25°C)

| Charac | teristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|----------------------------------|----------------------|---|-----|------|-----|------|
| Gate leakage cu | irrent | I _{GSS} | V _{GS} = ±25 V, V _{DS} = 0 V | | | ±10 | μA |
| Gate-source bre | eakdown voltage | V (BR) GSS | I _G = ±10 μA, V _{DS} = 0 V | ±30 | | | V |
| Drain cut-off cu | rrent | I _{DSS} | V _{DS} = 600 V, V _{GS} = 0 V | _ | _ | 100 | μA |
| Drain-source br | eakdown voltage | V (BR) DSS | I _D = 10 mA, V _{GS} = 0 V | 600 | _ | _ | V |
| Gate threshold v | voltage | V _{th} | V _{DS} = 10 V, I _D = 1 mA | 2.0 | _ | 4.0 | V |
| Drain-source O | N resistance | R _{DS (ON)} | V _{GS} = 10 V, I _D = 5 A | _ | 0.74 | 1.0 | Ω |
| Forward transfer | admittance | Y _{fs} | V _{DS} = 10 V, I _D = 5 A | 3.4 | 6.8 | _ | S |
| Input capacitance | put capacitance C _{iss} | | | _ | 1500 | _ | pF |
| Reverse transfer capacitance | | C _{rss} | V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz | _ | 13 | _ | |
| Output capacitance | | Coss | | | 140 | _ | |
| Switching time | Rise time | tr | $V_{GS} \stackrel{10 \text{ V}}{_{0 \text{ V}}} \prod_{\substack{O \text{ V} \\ O \text{ C} \\ O \text{ V}}} \prod_{\substack{O \text{ C} \\ O \text{ V} \\ O \text$ | _ | 15 | _ | |
| | Turn-on time | t _{on} | | _ | 55 | _ | 20 |
| | Fall time | t _f | | _ | 27 | _ | ns |
| | Turn-off time | t _{off} | Duty $\leq 1\%$, t _w = 10 µs | _ | 145 | _ | |
| Total gate charge (gate-source plus gate-drain) | | Qg | | _ | 38 | _ | |
| Gate-source charge | | Q _{gs} | V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 10 A | | 21 | _ | nC |
| Gate-drain ("miller") Charge | | Q _{gd} | | | 17 | — | |

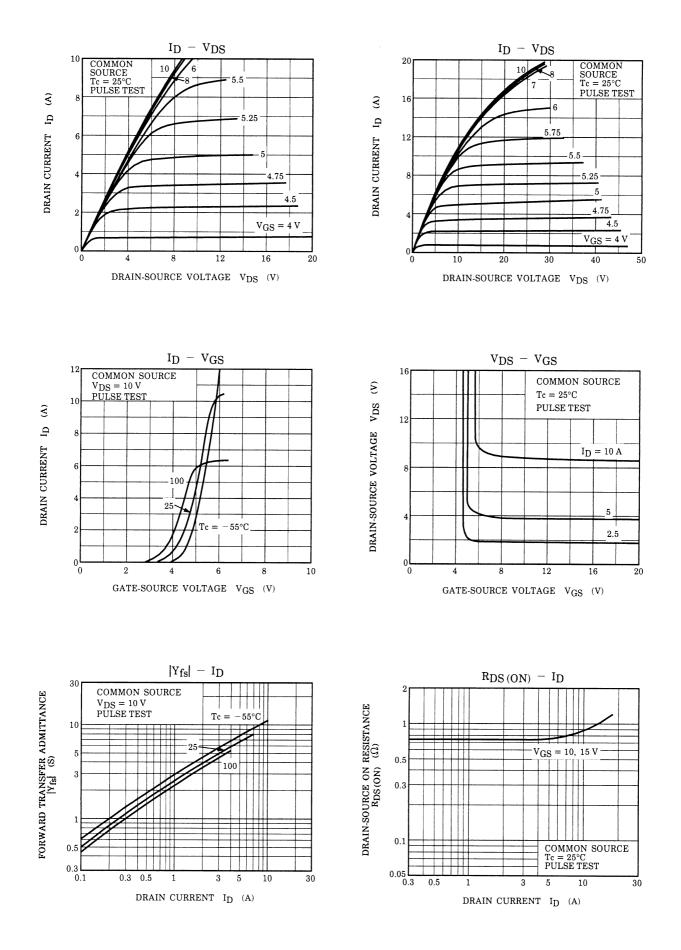
Source–Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--|------------------|---|-----|------|------|------|
| Continuous drain reverse current (Note 1) | I _{DR} | — | | _ | 10 | А |
| Pulse drain reverse current (Note 1) | I _{DRP} | — | _ | _ | 30 | А |
| Forward voltage (diode) | V _{DSF} | I _{DR} = 10 A, V _{GS} = 0 V | _ | _ | -1.7 | V |
| Reverse recovery time | t _{rr} | I _{DR} = 10 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs | _ | 1600 | | ns |
| Reverse recovery charge | Qrr | dI _{DR} / dt = 100 A / μs | | 17 | | μC |

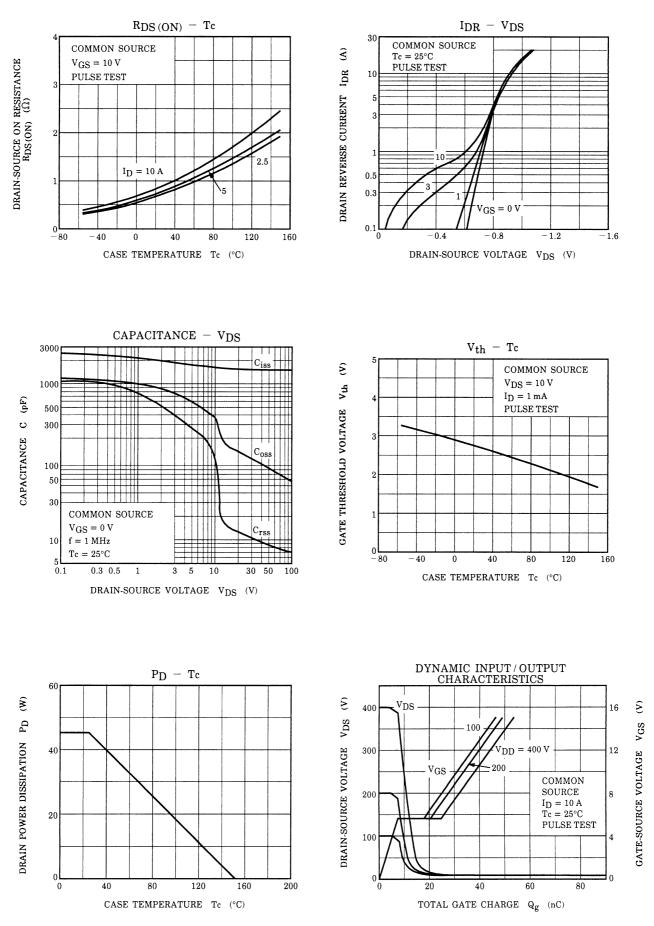
Marking

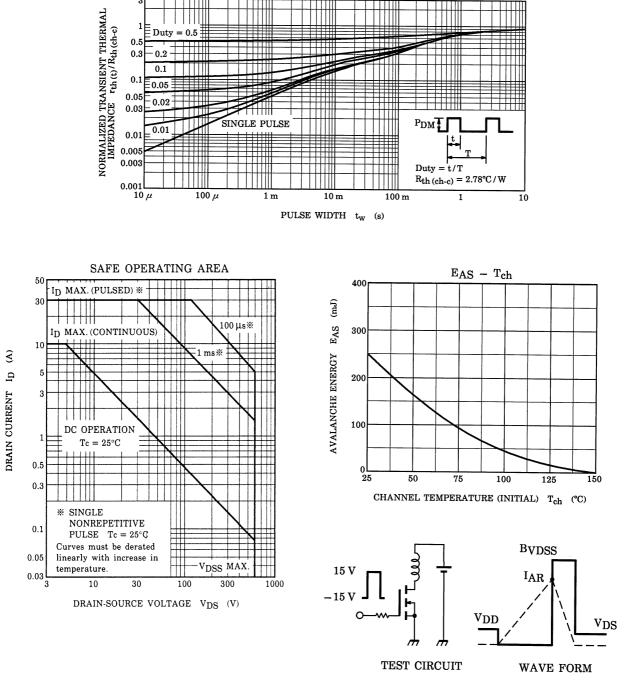


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 $r_{th} - t_w$

 $\begin{array}{ll} \mathrm{R_{G}=25\ \Omega} \\ \mathrm{V_{DD}=90\ V,\ L=4.41\ mH} \end{array} \qquad \mathrm{E_{AS}=\frac{1}{2}\cdot L\cdot I^{2}\cdot \left(\frac{\mathrm{B}\mathrm{VDSS}}{\mathrm{B}\mathrm{VDSS}-\mathrm{VDD}}\right)} \end{array}$

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